

MLC Mini SATA III Module

PHANES-K Series

(JEDEC MO-300A)

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Product Features

■ Flash IC

- TOSHIBA 15nm NAND Flash IC.
- Multi-Level Cell (MLC) management

■ Compatibility

- SATA Revision 3.2
- SATA 1.5Gb/s; SATA 3Gb/s & SATA 6Gb/s data transfer rate.
- ATA-8 ACS4 command set

Additional Capabilities

- S.M.A.R.T.*¹ (Self-Monitoring, Analysis and Reporting Technology) feature set support.
- Thermal Monitor for SSD's temperature.
- Native Command Queuing (NCQ) support.
- TRIM maintenance command support.
- Both Static & Dynamic wear-leveling algorithm
- Hardware Low Density Parity Check Code, LDPC support.

■ Mechanical

- JEDEC MO-300A full size Solid State Drive
- 52 pos. Edge Connector, PCI Express (PCIe) mini
- Dimension: 50.8 mm x 29.85 mm.
- Weight: 8.00 g / 0.28 oz.

■ Power Operating Voltage +3.3V±5%

Read Mode: 1,650.0 mW (max.)

- Write Mode: 2,690.0 mW (max.)

- Idle Mode: 285.0 mW (max.)

■ Performance (Maximum value) ²

- Sequential Read: 550.0 MB/sec. (max.)

- Sequential Write: 490.0 MB/sec. (max.)

■ Capacity

- 16GB, 32GB, 64GB, 128GB, 256GB, 512GB and 1TB

■ Reliability

- **TBW:** Up to 1,080 TBW at 1TB Capacity. (Client workload by JESD-219A)

- ECC: Designed with hardware LDPC ECC engine with hard-decision and soft-decision decoding.
- Temperature: (Operating)

Standard Grade: 0°C ~ +70°C

Wide Temp. Grade: -40°C ~ +85°C

- Vibration: 80 Hz to 2000 Hz, 20G, 3 axes.
- Shock: 0.5ms, 1500 G, 3 axes

■ Certifications and Declarations

- Certifications: CE & FCC

- **Declarations**: RoHS & REACH

Remarks:

- 1. Support official S.M.A.R.T. Utility.
- 2. Sequential performance is based on CrystalDiskMark

5.1.2 with file size 1000MB



Order Information

I. Part Number List

♦ APRO MLC Mini SATA III Module (mSATA) PHANES-K Series

Product Picture	Grade	Standard grade (0°C ~ 70°C)	Wide Temp Grade (-40°C ~ +85°C)
NZGSP PERMITTOLITY	16GB	SBMSM016G-PKCTM-(W/T/WT)	WBMSM016G-PKCTM-(W/T/WT)C
	32GB	SBMSM032G-PKCTM-(W/T/WT)	WBMSM032G-PKCTM-(W/T/WT)C
	64GB	SBMSM064G-PKCTM-(W/T/WT)	WBMSM064G-PKCTM-(W/T/WT)C
	128GB	SBMSM128G-PKCTM-(W/T/WT)	WBMSM128G-PKCTM-(W/T/WT)C
	256GB	SBMSM256G-PKCTM-(W/T/WT)	WBMSM256G-PKCTM-(W/T/WT)C
	512GB	SBMSM512G-PKCTM-(W/T/WT)	WBMSM512G-PKCTM-(W/T/WT)C
	1TB	SBMSM001T-PKCTM-(W/T/WT)	WBMSM001T-PKCTM-(W/T/WT)C

Notes:

C: Special conformal coating treated on whole PCBA which may support wide temp. grade operating temperature -40°C ~ +85°C

II. Part Number Decoder:

X1 X2 X3 X4 X5 X6 X7 X8 X9—X11 X12 X13 X14 X15—X17 X18

X1 : Grade

S: Standard Grade – operating temp. 0° C ~ 70 ° C

W: Wide Temp. Grade- operating temp. -40 $^{\circ}$ C $^{\sim}$ +85 $^{\circ}$ C

X2: The material of case

B: Bare PCBA w/o Casing

X3 X4 X5 : Product category

MSM: mini SATA III Module

X6 X7 X8 X9 : Capacity

 016G:
 16GB
 128G:
 128GB

 032G:
 32GB
 256G:
 256GB

 064G:
 64GB
 512G:
 512GB

001T:

1TB

X11 : Controller

P: PHANES Series

X12 : Controller version

A, B, C.....

X13 : Controller Grade

C: Commercial grade

X14 : Flash IC

T: Toshiba NAND Flash IC

X15 : Flash IC grade / Type

M: MLC-NAND Flash IC

X17 X18 : Reserved for specific requirement

Blank: Standard product w/o thermal sensor and

conformal-coating

W: Write Protection Switch (optional)

T: Thermal Sensor (optional)

WT: Write Protection Switch + Thermal Sensor (optional)

C: Conformal coating (optional)



Revision History

Revision	Description	Date
1.0	Initial release.	2018/08/30
1.1	Updated Version	2018/11/28
2.0	Updated document form	2019/05/30



Contents

Pro	duct F	- eatures 2 -
Orc	ler Inf	formation 3 -
	1.	Part Number List - 3 -
	1.	Part Number Decoder: 3 -
Rev	vision .	History 4 -
Cor	ntents	5 -
1.		Introduction 6 -
	1.1.	<i>Scope</i> 7 -
	1.2.	Flash Management Technology - Static & Dynamic Wear Leveling 7 -
	1.3.	Bad Block Management 7 -
2.		Product Specifications 8 -
	2.1.	System Environmental Specifications8 -
	2.2.	System Power Requirements8 -
	2.3.	System Performance 8 -
	2.4.	System Reliability9 -
	2.5.	Physical Specifications 9 -
	2.6.	Conformal coating 11 -
3.		Interface Description 11 -
	3.1.	MLC mini SATA III Module interface 11 -
	3.2.	Pin Assignments 12 -
Ap	pendi	ix A: Limited Warranty 13 -



1. Introduction

APRO MLC Mini SATA III Module (mSATA) PHANES-K Series provides high capacity flash memory Solid State Drive (SSD) that electrically complies with SATA Revision 3.2 standard. APRO MLC Mini SATA III Module (mSATA) PHANES-K Series support SATA 1.5Gb/s; SATA 3Gb/s & SATA 6Gb/s data transfer rate with high performance. It is designed with mSATA form factor by JEDEC MO-300A standard, and the available disk capacities are 16GB, 32GB, 64GB, 128GB, 256GB, 512GB and 1TB. The operating temperature grade is optional for Standard grade 0°C ~ 70°C and wide temp grade with conformal coating supports -40°C ~ +85°C.

APRO MLC Mini SATA III Module (mSATA) PHANES-K Series provide the ultra-high random speed for heavy-loading embedded or server operations with space constraints for host computing systems; the performance of sequential read is up to 550.0 MB/sec. (max.), and sequential write is up to 490.0 MB/sec. (max.).

APRO MLC Mini SATA III Module (mSATA) PHANES-K Series provides a high level interface to the host computer. This interface allows a host computer to issue commands to the APRO MLC Mini SATA III Module (mSATA) PHANES-K Series to read or write blocks of memory. A powerful hardware design is architecture multiplied LDPC (Low Density Parity Check) for Error Correcting Coding (ECC). APRO MLC Mini SATA III Module (mSATA) PHANES-K Series intelligent controller manages interface protocols, data storage and retrieval as well as ECC, bad block management and diagnostics, power management and clock control.

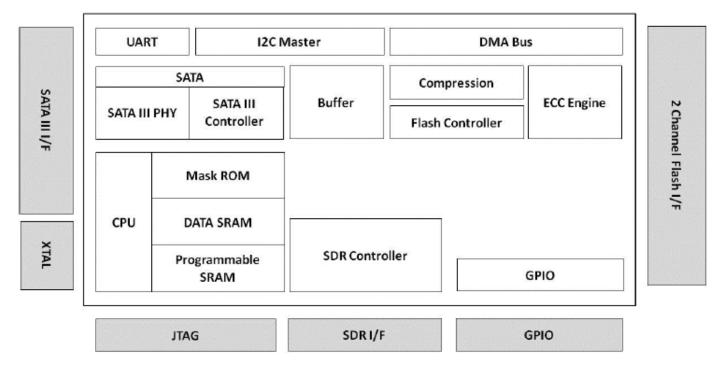


Figure 1: APRO MLC Mini SATA III Module (mSATA) PHANES-K Series block diagram



1.1. Scope

This document describes features, specifications and installation guide of APRO MLC Mini SATA III Module (mSATA) PHANES-K Series. In the appendix, there provides order information, warranty policy, RMA/DOA procedure for the most convenient reference.

1.2. Flash Management Technology - Static & Dynamic Wear Leveling

NAND flash devices can only undergo a limited number of program/erase cycles, and in most cases, the flash media are not used evenly. If some areas get updated more frequently than others, the lifetime of the device would be reduced significantly. Thus, Wear Leveling is applied to extend the lifespan of NAND Flash by evenly distributing write and erase cycles across the media.

APRO MLC Mini SATA III Module (mSATA) PHANES-K Series provides advanced Wear Leveling algorithm, which can efficiently spread out the flash usage through the whole flash media area. Moreover, by implementing both dynamic and static Wear Leveling algorithms, the life expectancy of the NAND flash is greatly improved.

1.3. Bad Block Management

Early Bad Block

The fault block generated during the manufacturing process of NAND Flash is called Early Bad Block.

Later Bad Block

In the process of use, as the number of operations of writing and erasing increases, a fault block is gradually generated, which is called a Latter Bad Block.

Bad block management is a management mechanism for a bad block to be detected by the control IC and mark bad blocks in the NAND Flash and improve the reliability of data access. The bad block management mechanism of the control IC will establish a **Bad Block Table** when the NAND Flash is started for the first time, and will also record the errors found in the process of use in the bad block table, and data is ported to new valid blocks to avoid data loss.

In order to detect the initial bad blocks to handle run time bad blocks, APRO MLC Mini SATA III Module (mSATA) PHANES-K Series provides the **Bad Block Management** scheme. It remaps a bad block to one of the reserved blocks so that the data contained in one bad block is not lost and new data writes on a bad block is avoided.



2. Product Specifications

For all the following specifications, values are defined at ambient temperature and nominal supply voltage unless otherwise stated.

2.1. System Environmental Specifications

Table 1: Environmental Specification

APRO MLC Mini SA	ATA III Module (mSATA)	Standard Grade	Wide Temp Grade	
PHANES-K Series		SBMSMxxxG-PKCTM WBMSMxxxG-PKCTM		
Tommowatuwa	Operating:	0°C ~ +70°C	-40°C ~ +85°C	
Temperature	Non-operating:	-20°C ~ +80°C	-50°C ~ +95°C	
Humidity Operating & Non-operating:		10% ~ 95% non-condensing		
Vibration Frequency/Acceleration:		80 Hz to 2000 Hz, 20G, 3 axes		
Shock Operating & Non-operating:		0.5ms, 1500 G, 3 axes		
Temperature:		24°C		
Electrostatic Relative Humidity:		49% (RH)		
Discharge (ESD)	+/-4KV:	Device functions are affected, but EUT will be back to its normal or		
+/-4KV.		operational state automatically.		

2.2. System Power Requirements

Table 2: Power Requirement

APRO MLC Mini SATA III Module (mSATA) PHANES-K Series				
DC Input Voltage (VCC)	+3.3V±5%			
	Reading Mode :	1,650.0 mW (max.)		
Maximum average value	Writing Mode :	2,690.0 mW (max.)		
	I dle Mode :	285.0 mW (max.)		

2.3. System Performance

Table 3: System Performances

Data Transfer Mode supporting		Serial ATA Gen-III (6.0Gb/s = 768MB/s)						
Maximum Performance	Capacity	16GB	32GB	64GB	128GB	256GB	512GB	1TB
	Sequential Read (MB/s)	320.0	550.0	550.0	550.0	550.0	550.0	530.0
	Sequential Write (MB/s)	85.0	160.0	310.0	465.0	490.0	490.0	435.0

Note:

- The performance was measured using CrystalDiskMark v5.0x64 with SATA 6Gbps host.
- > Samples were built using Toshiba 15nm Toggle MLC NAND.
- > Performance may differ according to flash configuration, SDR configuration, and platform.
- > The table above is for reference only. The criteria for MP (mass production) and for accepting goods shall be discussed based on different flash configuration.



2.4. System Reliability

Table 4: System Reliability

Wear-leveling	Algorithms	Static and Dynamic wear-leveling algorithms		
Bad Block Management		Supportive		
ECC Technology		Hardware design LDPC (Low Density Parity Check)		
Erase counts		NAND MLC Flash Cell Level : 3K P/E Cycles		
TBW (Tera Byt	TBW (Tera Bytes Written)			
	16GB	6.0		
	32GB	13.0		
	64GB	30.0		
Capacity	128GB	87.0		
	256GB	198.0		
	512GB	540.0		
	1TB	1,080.0		

Note:

- Client workload by JESD-219A
- > Samples were built using Toshiba 15nm Toggle MLC NAND flash.
- > The endurance of SSD could be estimated based on user behavior, NAND endurance cycles, and write amplification factor.

 It is not guaranteed by flash vendor.

2.5. Physical Specifications

Refer to Table 5 and see Figure 2 for APRO MLC Mini SATA III Module (mSATA) PHANES-K Series physical specifications and dimensions.

Table 5: Physical Specifications of APRO MLC Mini SATA III Module (mSATA) PHANES-K Series

Length:	50.8 mm
Width:	29.85 mm
Weight:	8.0 g / 0.28 oz.

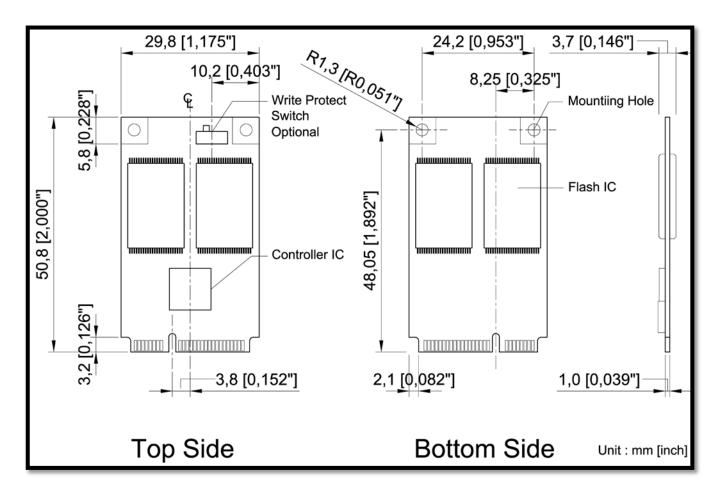


Figure 2: APRO Mini SATA III Module (JEDEC MO-300A) Dimension



2.6. Conformal coating

Conformal coating is a protective, dielectric coating designed to conform to the surface of an assembled printed circuit board. Commonly used conformal coatings include silicone, acrylic, urethane and epoxy. APRO applies only silicone on APRO storages products upon requested especially by customers. The type of silicone coating features good thermal shock resistance due to flexibility. It is also easy to apply and repair.

Conformal coating offers protection of circuitry from moisture, fungus, dust and corrosion caused by extreme environments. It also prevents damage from those Flash storages handling during construction, installation and use, and reduces mechanical stress on components and protects from thermal shock. The greatest advantage of conformal coating is to allow greater component density due to increased dielectric strength between conductors.

APRO use MIL-I-46058C silicon conformal coating

3. Interface Description

3.1. Mini SATA III Module interface

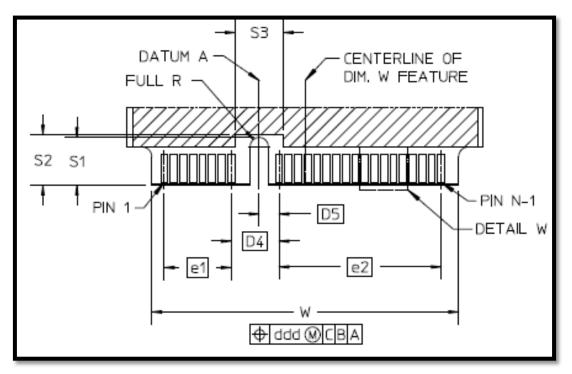


Figure 3: The connectors of Signal Segment and Power Segment



3.2. Pin Assignments

APRO MLC Mini SATA III Module (mSATA) PHANES-K Series operates with standard SATA pin-out. The pin assignments are listed in below table 6.

Table 6 - Pin Assignments

Signal Name	Pin #	Pin #	Signal Name
NC	1	2	+3.3V
NC	3	4	DGND
NC	5	6	NC
NC	7	8	NC
DGND	9	10	NC
NC	11	12	NC
NC	13	14	NC
DGND	15	16	NC
1		•	
NC	17	18	DGND
NC	19	20	NC
SATA GND	21	22	NC
TX+	23	24	+3.3V
TX-	25	26	SATA GND
SATA GND	27	28	NC
SATA GND	29	30	NC
RX-	31	32	NC
RX+	33	34	DGND
SATA GND	35	36	NC
SATA GND	37	38	NC
+3.3V	39	40	DGND
+3.3V	41	42	NC
NC	43	44	DEVSLP
NC	45	46	NC
NC	47	48	NC
DAS	49	50	DGND
GND	51	52	+3.3V



Appendix A: Limited Warranty

APRO warrants your MLC mini SATA III Module against defects in material and workmanship for the life of the drive. The warranty is void in the case of misuse, accident, alteration, improper installation, misapplication or the result of unauthorized service or repair. The implied warranties of merchantability and fitness for a particular purpose, and all other warranties, expressed or implied, except as set forth in this warranty, shall not apply to the products delivered. In no event shall APRO be liable for any lost profits, lost savings or other incidental or consequential damages arising out of the use of, or inability to use, this product.

BEFORE RETURNING PRODUCT, A RETURN MATERIAL AUTHORIZATION (RMA) MUST BE OBTAINED FROM APRO.

Product shall be returned to APRO with shipping prepaid. If the product fails to conform based on customers' purchasing orders, APRO will reimburse customers for the transportation charges incurred.

WARRANTY PERIOD:

• MLC (Standard grade / Wide temp. grade) 2 years / Within 3K Erasing Counts

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